

# 74F245SCX Datasheet



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DiGi Electronics Part Number	74F245SCX-DG
Manufacturer	onsemi
Ianufacturer Product Number	74F245SCX
Description	IC TXRX NON-INVERT 5.5V 20SOIC
Detailed Description	Transceiver, Non-Inverting 1 Element 8 Bit per Elem ent 3-State Output 20-SOIC

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# Purchase and inquiry

Manufacturer Product Number:	Manufacturer:
74F245SCX	onsemi
Series:	Product Status:
74F	Obsolete
Logic Type:	Number of Elements:
Transceiver, Non-Inverting	1
Number of Bits per Element:	Input Type:
8	-
Output Type:	Current - Output High, Low:
3-State	3mA, 24mA; 15mA, 64mA
Voltage - Supply:	Operating Temperature:
4.5V ~ 5.5V	0°C ~ 70°C (TA)
Mounting Type:	Package / Case:
Surface Mount	20-SOIC (0.295", 7.50mm Width)
Supplier Device Package:	Base Product Number:
20-SOIC	74F245

# **Environmental & Export classification**

Moisture Sensitivity Level (MSL):	REACH Status:
1 (Unlimited)	REACH Unaffected
ECCN:	HTSUS:
EAR99	8542.39.0001



January 2008

# 74F245 Octal Bidirectional Transceiver with 3-STATE Outputs

# Features

- Non-inverting buffers
- Bidirectional data path
- A outputs sink 24mA
- B outputs sink 64mA

# **General Description**

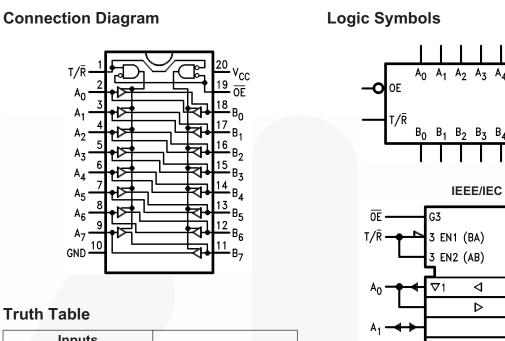
The 74F245 contains eight non-inverting bidirectional buffers with 3-STATE outputs and is intended for busoriented applications. Current sinking capability is 24mA at the A Ports and 64mA at the B Ports. The Transmit/Receive  $(T/\overline{R})$  input determines the direction of data flow through the bidirectional transceiver. Transmit (active HIGH) enables data from A Ports to B Ports; Receive (active LOW) enables data from B Ports to A Ports. The Output Enable input, when HIGH, disables both A and B Ports by placing them in a High Z condition.

# **Ordering Information**

Order Number	Package Number	Package Description
74F245SC	M20B	20-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-013, 0.300" Wide
74F245SJ	M20D	20-Lead Small Outline Package (SOP), EIAJ TYPE II, 5.3mm Wide
74F245MSA	MSA20	20-Lead Shrink Small Outline Package (SSOP), JEDEC MO-150, 5.3mm Wide
74F245MTC	MTC20	20-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 4.4mm Wide
74F245PC	N20A	20-Lead Plastic Dual-In-Line Package (PDIP), JEDEC MS-001, 0.300" Wide

Device also available in Tape and Reel. Specify by appending suffix letter "X" to the ordering number.

All packages are lead free per JEDEC: J-STD-020B standard.



Inputs		
ŌE	T/R	Output
L	L	Bus B Data to Bus A
L	Н	Bus A Data to Bus B
Н	Х	High Z State

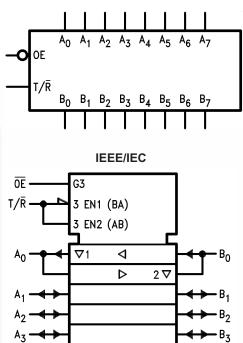
H = HIGH Voltage Level

L = LOW Voltage Level

X = Immaterial

# **Unit Loading/Fan Out**

Pin Names	Description	U.L. HIGH/LOW	Input I <sub>IH</sub> /I <sub>IL</sub> Output I <sub>OH</sub> /I <sub>OL</sub>
ŌĒ	Output Enable Input (Active LOW)	1.0/2.0	20µA/–1.2mA
T/R	Transmit/Receive Input	1.0/2.0	20µA/–1.2mA
A <sub>0</sub> -A <sub>7</sub>	Side A Inputs or	3.5/1.083	70 μA/–0.65mA
	3-STATE Outputs	150/40 (38.3)	–3 mA/24mA (20mA)
B <sub>0</sub> B <sub>7</sub>	Side B Inputs or	3.5/1.083	70µA/–0.65mA
	3-STATE Outputs	600/106.6 (80)	–12mA/64mA (48mA)



B₄ B<sub>5</sub> B<sub>6</sub>

B-7

# **Absolute Maximum Ratings**

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only.

Symbol	Parameter	Rating
T <sub>STG</sub>	Storage Temperature	–65°C to +150°C
T <sub>A</sub>	Ambient Temperature Under Bias	–55°C to +125°C
Τ <sub>J</sub>	Junction Temperature Under Bias	–55°C to +150°C
V <sub>CC</sub>	V <sub>CC</sub> Pin Potential to Ground Pin	-0.5V to +7.0V
VI	Input Voltage <sup>(1)</sup>	-0.5V to +7.0V
lı	Input Current <sup>(1)</sup>	-30mA to +5.0mA
	Voltage Applied to Output in HIGH State (with $V_{CC} = 0V$ )	
	Standard Output	–0.5V to $V_{CC}$
	3-STATE Output	-0.5V to +5.5V
	Current Applied to Output in LOW State (Max.)	twice the rated I <sub>OL</sub> (mA)
	ESD Last Passing Voltage (Min.)	4000V

Note:

1. Either voltage limit or current limit is sufficient to protect inputs.

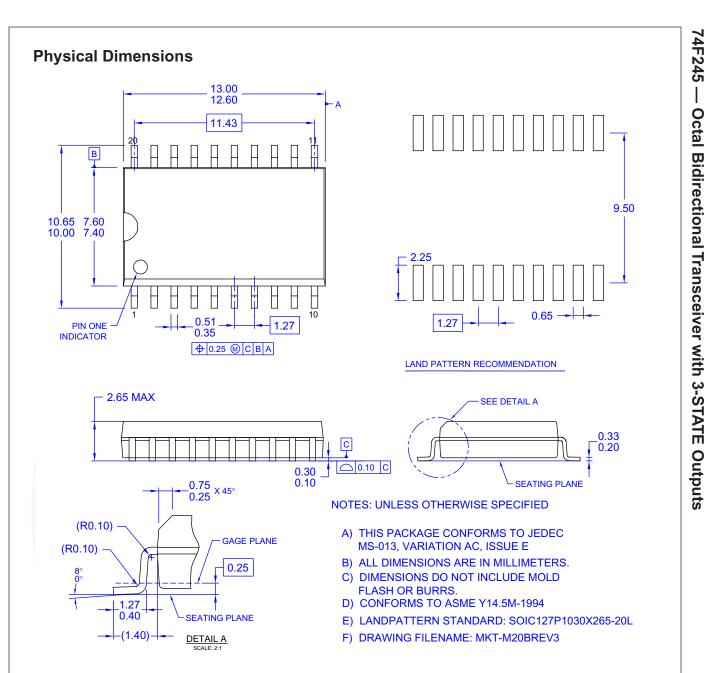
# **Recommended Operating Conditions**

The Recommended Operating Conditions table defines the conditions for actual device operation. Recommended operating conditions are specified to ensure optimal performance to the datasheet specifications. Fairchild does not recommend exceeding them or designing to absolute maximum ratings.

Symbol	Parameter	Rating
T <sub>A</sub>	Free Air Ambient Temperature	0°C to +70°C
V <sub>CC</sub>	Supply Voltage	+4.5V to +5.5V

Symbol	Parameter		V <sub>CC</sub>	Conditions	Min.	Тур.	Max.	Units
V <sub>IH</sub>	Input HIGH Voltage			Recognized as a HIGH Signal	2.0			V
V <sub>IL</sub>	Input LOW Voltage			Recognized as a LOW Signal			0.8	V
V <sub>CD</sub>	Input Clamp Diode Volt	age	Min.	$I_{IN} = -18 \text{mA}$			-1.2	V
V <sub>OH</sub>	Output HIGH Voltage	10% V <sub>CC</sub>	Min.	$I_{OH} = -3mA(A_n)$	2.4			V
		10% V <sub>CC</sub>		$I_{OH} = -15 \text{mA} (B_n)$	2.0			
		5% V <sub>CC</sub>		$I_{OH} = -3mA(A_n)$	2.7			
V <sub>OL</sub>	Output LOW Voltage	10% V <sub>CC</sub>	Min.	$I_{OL} = 24 \text{mA} (A_n)$			0.5	V
		10% V <sub>CC</sub>		$I_{OL} = 64 \text{mA} (B_n)$			0.55	
I <sub>IH</sub>	Input HIGH Current		Max.	V <sub>IN</sub> = 2.7V			5.0	μA
I <sub>BVI</sub>	Input HIGH Current Breakdown Test		Max.	$V_{IN} = 7.0V \ (\overline{OE}, T/\overline{R})$			7.0	μA
I <sub>BVIT</sub>	Input HIGH Current Breakdown (I/O)		Max.	$V_{IN} = 5.5V (A_n, B_n)$			0.5	mA
I <sub>CEX</sub>	Output HIGH Leakage Current		Max.	$V_{OUT} = V_{CC} (A_n, B_n)$			50	μA
V <sub>ID</sub>	Input Leakage Test		0.0	I <sub>ID</sub> = 1.9μA, All Other Pins Grounded	4.75			V
I <sub>OD</sub>	Output Leakage Circuit Current		0.0	V <sub>IOD</sub> = 150mV, All Other Pins Grounded			3.75	μA
Ι <sub>ΙL</sub>	Input LOW Current		Max.	$V_{IN} = 0.5V (T/\overline{R}, \overline{OE})$			-1.2	mA
I <sub>IH</sub> + I <sub>OZH</sub>	Output Leakage Currer	nt	Max.	$V_{OUT} = 2.7V (A_n, B_n)$			70	μA
I <sub>IL</sub> + I <sub>OZL</sub>	Output Leakage Current		Max.	$V_{OUT} = 0.5V (A_n, B_n)$			-650	μA
I <sub>OS</sub> Output Short-Circuit Current		out Short-Circuit Current Ma		$V_{OUT} = 0V (A_n)$	-60		-150	mA
				$V_{OUT} = 0V (B_n)$	-100		-225	
I <sub>ZZ</sub>	Bus Drainage Test		0.0V	$V_{OUT} = 5.25V(A_n, B_n)$			500	μA
I <sub>CCH</sub>	Power Supply Current		Max.	V <sub>O</sub> = HIGH		70	90	mA
I <sub>CCL</sub>	Power Supply Current		Max.	$V_{O} = LOW$		95	120	mA
I <sub>CCZ</sub>	Power Supply Current		Max.	V <sub>O</sub> = HIGH Z		85	110	mA

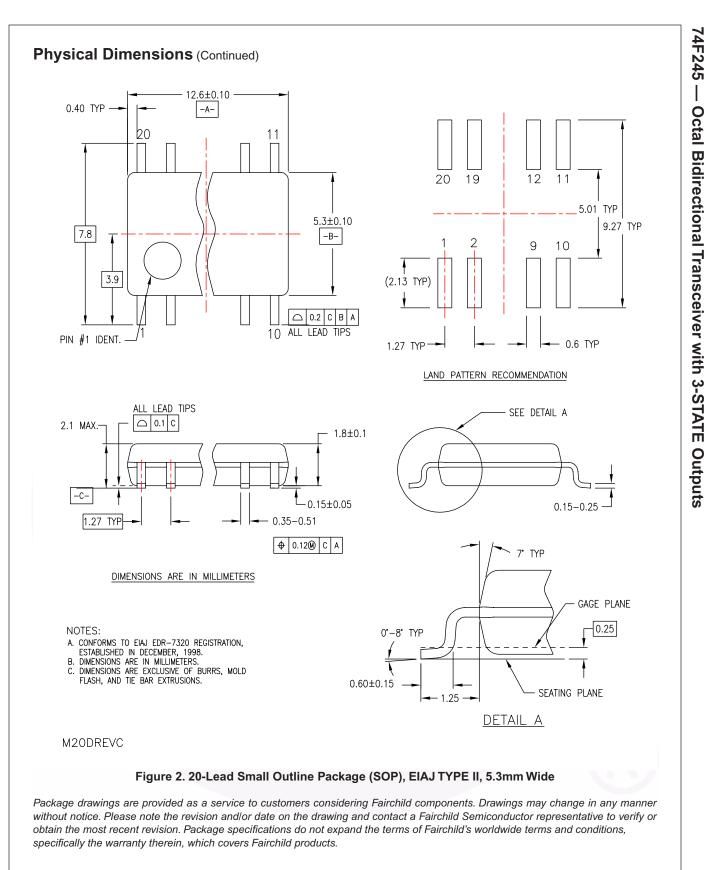
		$\label{eq:T_A} \begin{array}{l} \textbf{T}_{A} = \textbf{+25^{\circ}C},\\ \textbf{V}_{CC} = \textbf{+5.0V},\\ \textbf{C}_{L} = \textbf{50pF} \end{array}$		$T_A = -55^{\circ}C \text{ to } +125^{\circ}C,$ $C_L = 50pF$		$\label{eq:T_A} \begin{split} T_A &= 0^\circ C \text{ to } +70^\circ C, \\ C_L &= 50 p F \end{split}$			
Symbol	Parameter	Min.	Тур.	Max.	Min.	Max.	Min.	Max.	Units
t <sub>PLH</sub> , t <sub>PHL</sub>	Propagation Delay,	2.5	4.2	6.0	2.0	7.5	2.0	7.0	ns
	$A_n$ to $B_n$ or $B_n$ to $A_n$	2.5	4.2	6.0	2.0	7.5	2.0	7.0	
t <sub>PZH</sub> , t <sub>PZL</sub>	Output Enable Time	3.0	5.3	7.0	2.5	9.0	2.5	8.0	ns
		3.5	6.0	8.0	3.0	10.0	3.0	9.0	
t <sub>PHZ</sub> , t <sub>PLZ</sub>	Output Disable Time	2.0	5.0	6.5	2.0	9.0	2.0	7.5	ns
		2.0	5.0	6.5	2.0	10.0	2.0	7.5	



#### Figure 1. 20-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-013, 0.300" Wide

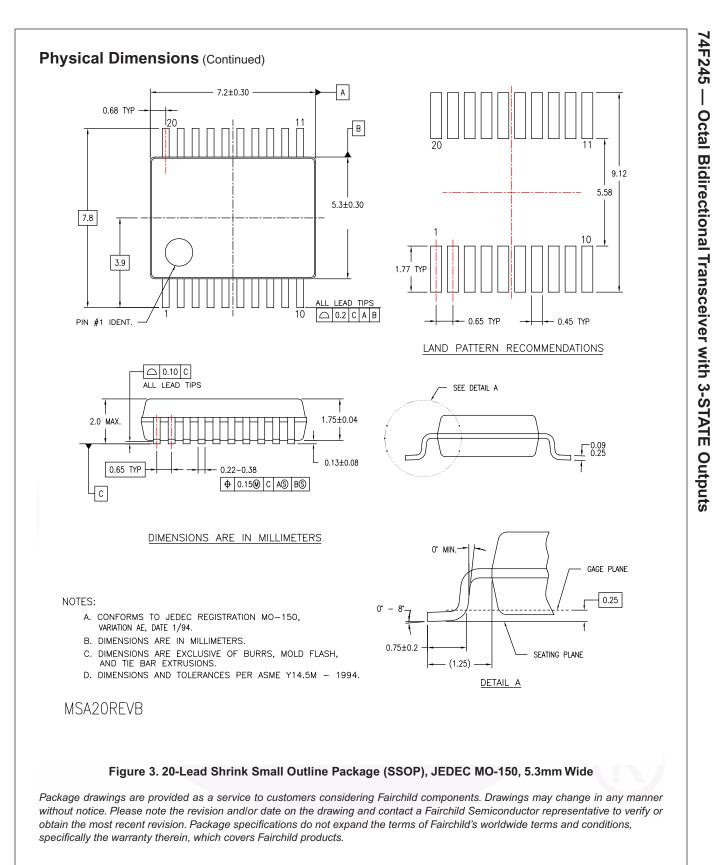
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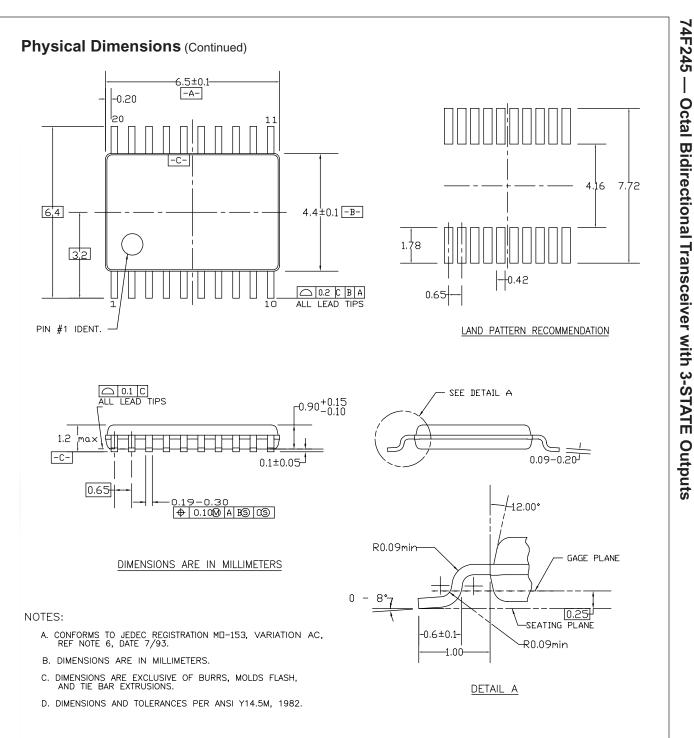


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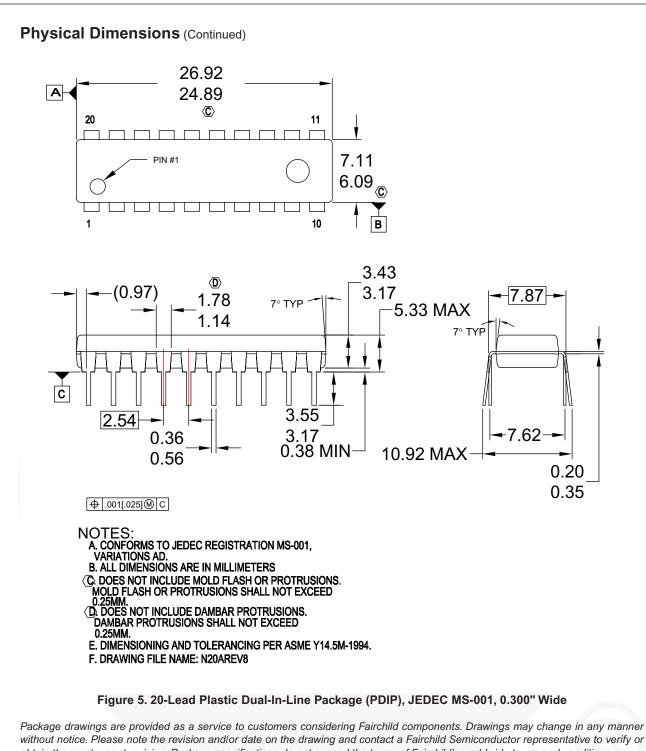
### MTC20REVD1

#### Figure 4. 20-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 4.4mm Wide

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